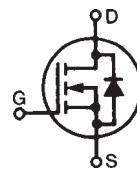
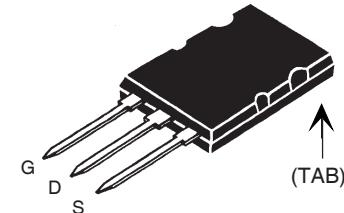


Polar™ Power MOSFET
HiPerFET™
IXFB300N10P

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode



V_{DSS} = 100V
 I_{D25} = 300A
 $R_{DS(on)}$ ≤ 5.5mΩ
 t_{rr} ≤ 200ns

PLUS264™ (IXFB)

G = Gate D = Drain
 S = Source TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ\text{C}$ to 175°C	100		V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 175°C , $R_{GS} = 1\text{M}\Omega$	100		V
V_{GSS}	Continuous	±20		V
V_{GSM}	Transient	±30		V
I_{D25}	$T_c = 25^\circ\text{C}$	300		A
I_{LRMS}	Leads Current Limit, RMS	75		A
I_{DM}	$T_c = 25^\circ\text{C}$, pulse width limited by T_{JM}	900		A
I_A	$T_c = 25^\circ\text{C}$	100		A
E_{AS}	$T_c = 25^\circ\text{C}$	3		J
dV/dt	$I_s \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 175^\circ\text{C}$	20		V/ns
P_D	$T_c = 25^\circ\text{C}$	1500		W
T_J		-55 ... +175		°C
T_{JM}		175		°C
T_{stg}		-55 ... +175		°C
T_L	1.6mm (0.062 in.) from case for 10s	300		°C
T_{SOLD}	Plastic body for 10s	260		°C
F_c	Mounting force	30..120/6.7..27		N/lb.
Weight		10		g

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	$V_{GS} = 0\text{V}$, $I_D = 3\text{mA}$	100		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 8\text{mA}$	3.0	5.0	V
I_{GSS}	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$		±200	nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$		25 1.5	μA mA
$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 50\text{A}$, Note 1		5.5	mΩ

Features

- Fast intrinsic diode
- Avalanche Rated
- Low $R_{DS(ON)}$ and Q_G
- Low package inductance

Advantages

- Easy to mount
- Space savings
- High power density
- Low gate drive requirement

Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC and DC motor drives
- Uninterrupted power supplies
- High speed power switching applications

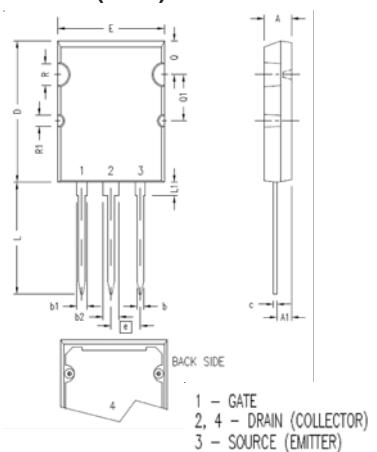
Symbol	Test Conditions (T _J = 25°C, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	V _{DS} = 10V, I _D = 60A, Note 1	55	92	S
C_{iss} C_{oss} C_{rss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	23	nF	
		6100	pF	
		417	pF	
t_{d(on)} t_r t_{d(off)} t_f	Resistive Switching Times V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 100A R _G = 1Ω (External)	36	ns	
		35	ns	
		56	ns	
		25	ns	
Q_{g(on)} Q_{gs} Q_{gd}	V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25}	279	nC	
		84	nC	
		107	nC	
R_{thJC}			0.10	°C/W
R_{thCS}		0.13		°C/W

Source-Drain Diode
Characteristic Values

(T_J = 25°C, unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	Max.
I _s	V _{GS} = 0V		300	A
I _{SM}	Repetitive, pulse width limited by T _{JM}		1000	A
V _{SD}	I _F = 100A, V _{GS} = 0V, Note 1		1.3	V
t_{rr} Q_{RM} I_{RM}	I _F = 150A, -di/dt = 100A/μs V _R = 50V	0.71	200	ns
		10		μC
				A

Note 1: Pulse test, t ≤ 300μs; duty cycle, d ≤ 2%.

PLUS264™ (IXFB) Outline


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.185	.209	4.70	5.31
A1	.102	.118	2.59	3.00
b	.037	.055	0.94	1.40
b1	.087	.102	2.21	2.59
b2	.110	.126	2.79	3.20
c	.017	.029	0.43	0.74
D	1.007	1.047	25.58	26.59
E	.760	.799	19.30	20.29
e	.215	BSC	5.46	BSC
L	.779	.842	19.79	21.39
L1	.087	.102	2.21	2.59
Q	.240	.256	6.10	6.50
Q1	.330	.346	8.38	8.79
ØR	.155	.187	3.94	4.75
ØR1	.085	.093	2.16	2.36

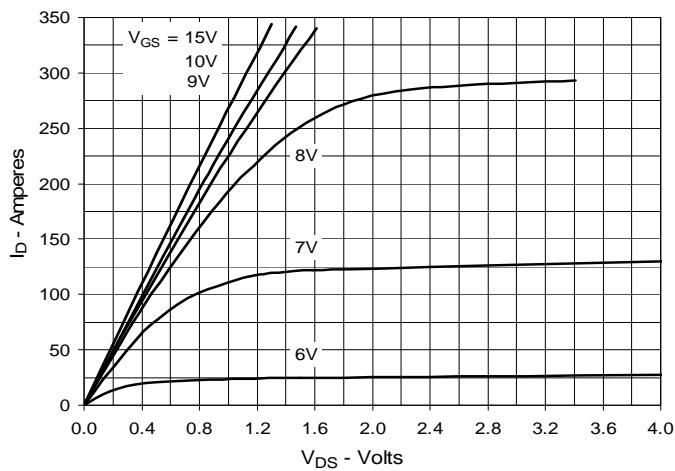
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

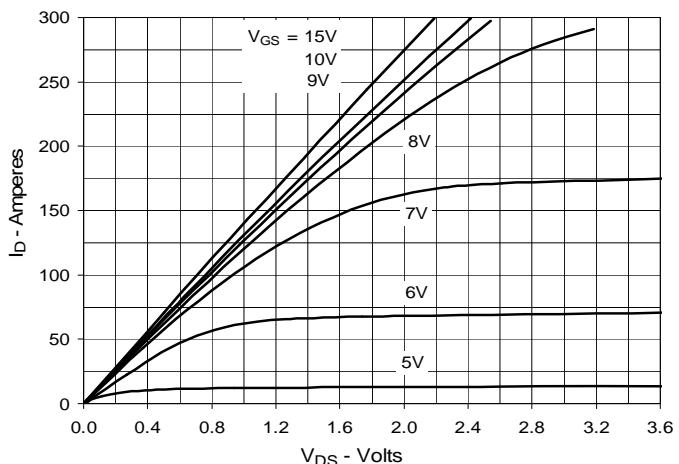
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

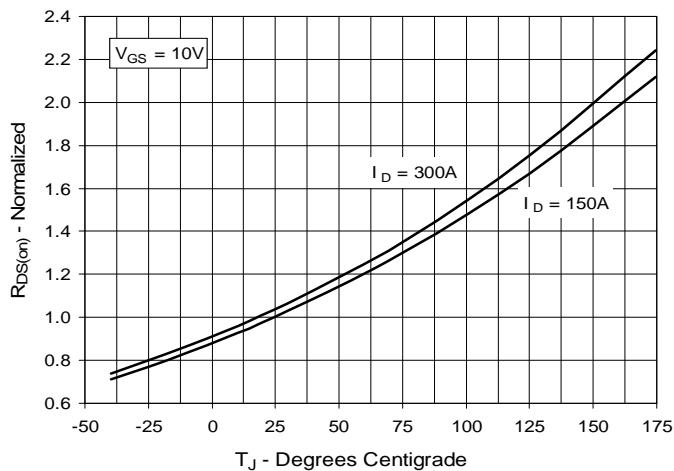
**Fig. 1. Extended Output Characteristics
@ 25°C**



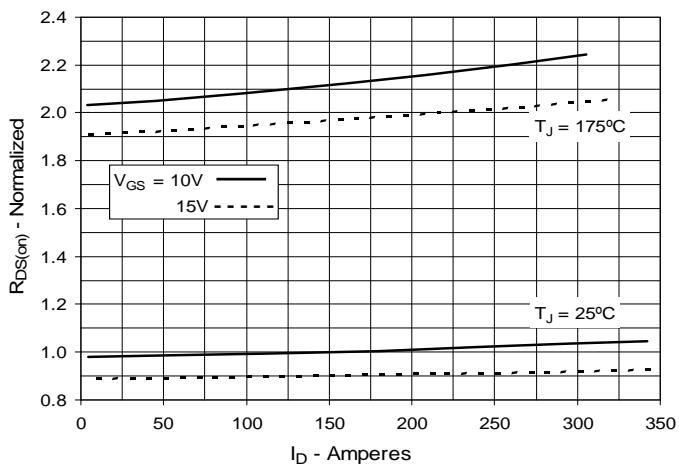
**Fig. 2. Output Characteristics
@ 150°C**



**Fig. 3. $R_{DS(on)}$ Normalized to $I_D = 150A$ Value
vs. Junction Temperature**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 150A$ Value
vs. Drain Current**



**Fig. 5. Maximum Drain Current vs.
Case Temperature**

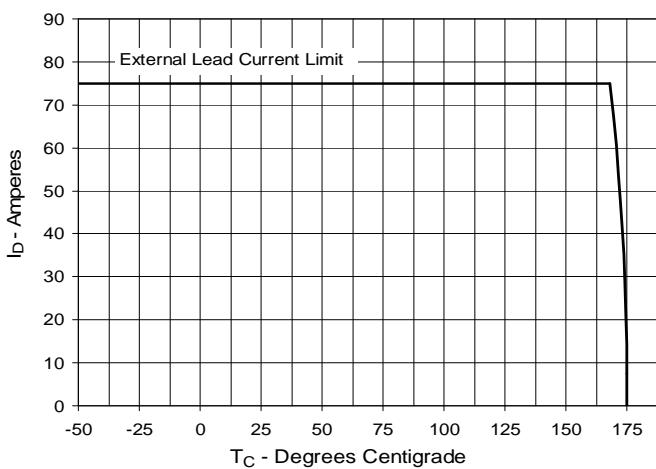


Fig. 6. Input Admittance

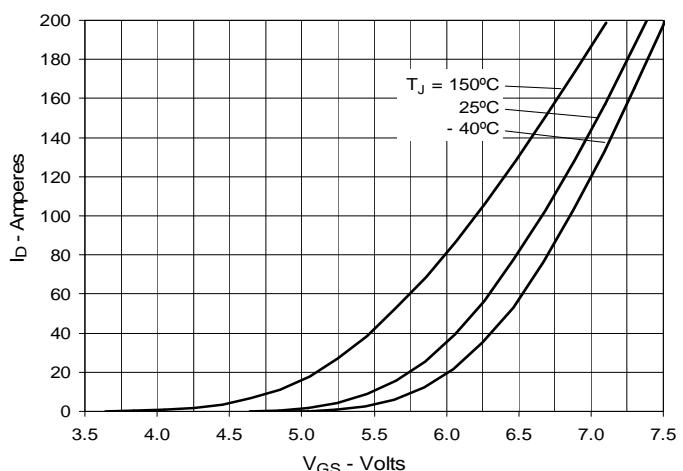
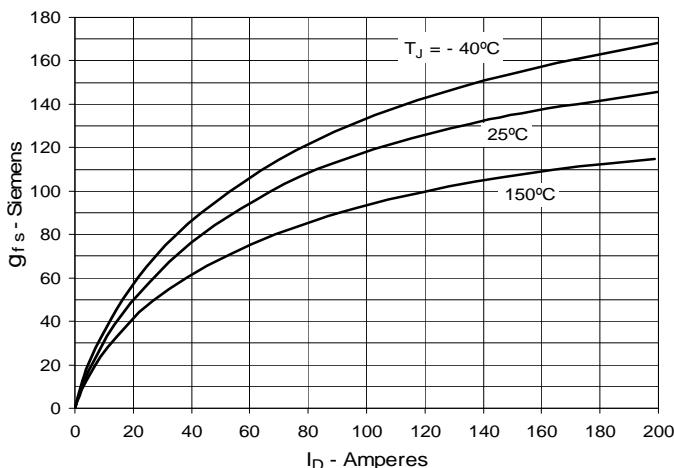
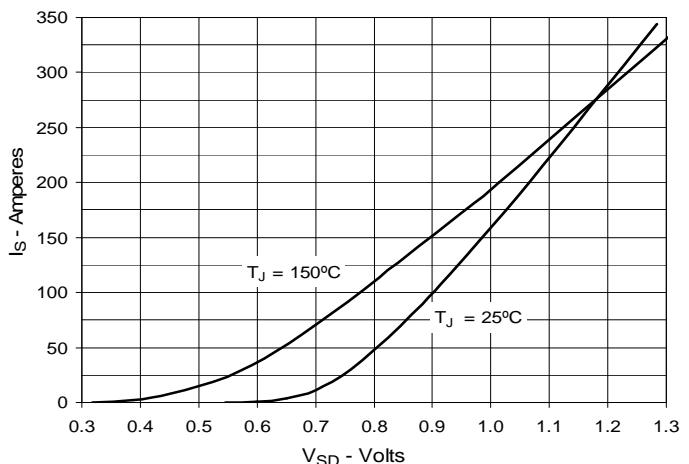
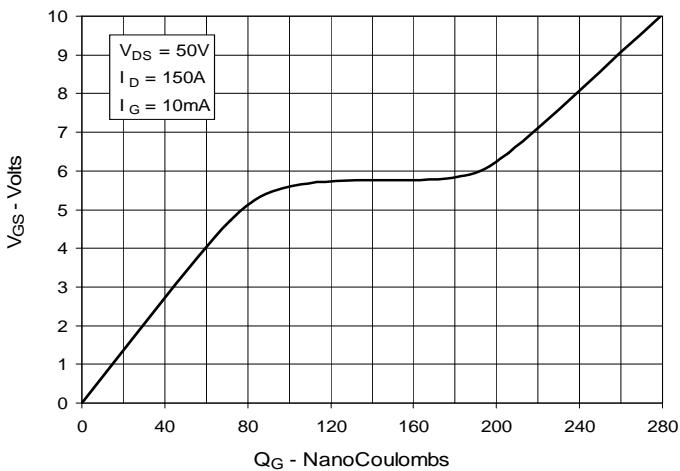
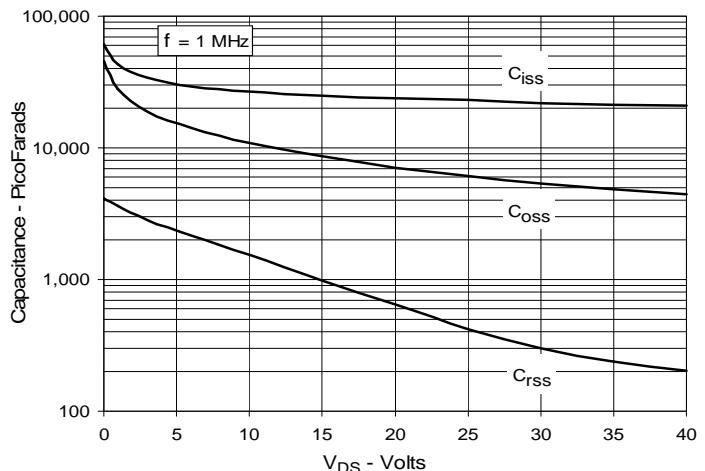
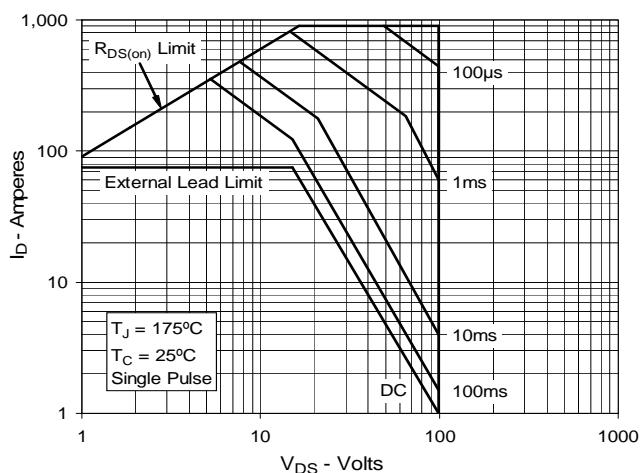


Fig. 7. Transconductance**Fig. 8. Forward Voltage Drop of Intrinsic Diode****Fig. 9. Gate Charge****Fig. 10. Capacitance****Fig. 11. Forward-Bias Safe Operating Area****Fig. 12. Maximum Transient Thermal Impedance**